



BRIGHTTEK
BRIGHTTEK (EUROPE) LIMITED

Brighten up The World With LED!



ISO/TS 16949:2009



BS EN ISO 14001:2004



QC 080000 IECQ HSPM

PRODUCT DATASHEET



- ▶ PLCC4 SMD with IC
- ▶ 5050IC 1.57t Series
- ▶ Red/Green/Blue

NOM65S69IC



Release Date: 07 September 2024 Version: A1.0



5050 IC-Integrated

RoHS
Compliant



FEATURES:

- **Package:** PLCC4 EIA STD Package with Integrated IC 104
- **Forward Current:** 5mA
- **Forward Voltage (typ.):** +3.8~+5.5V
- **Luminous Intensity (typ.):** 650mcd mixed white
- **Colour:** Red/Green/Blue
- **Wavelength:** 622/527/467nm
- **Viewing Angle:** 120°
- **Materials:**
 - Resin: Silicone (Water Clear)
- **Operating Temperature:** -40~+85°C
- **Storage Temperature:** -40~+105°C
- **IC Feature:**

RGB and driver chip are integrated in one package, to form a complete control of pixel point with constant current. One Pixel contains R, G, and B colour each can achieve 256 level brightness greyscales, which form 16,777,216 combination colours. Internal clock frequency operates at 800kHz. Serial data transmission signal by single wire.
- **Soldering methods:** IR Reflow soldering
- **Preconditioning:** acc. to JEDEC Level 5a
- **Packing:** 12mm tape with max.1000pcs/reel, ø180mm (7")

APPLICATIONS:

- Telecommunication
- Status Indicator
- Home Appliance
- Decoration Lighting
- Full Colour LED Strip
- Gaming Device

CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|-------------------------|------------------|---------------------------|------|
| DC Forward Current | I _F | 5 | mA |
| IC Power Supply Voltage | V _{DD} | +3.8~+6.0 | V |
| IC Input Voltage | V _I | -0.4~V _{DD} +0.4 | V |
| Operating Temperature | T _{OPR} | -40~+85 | °C |
| Storage Temperature | T _{STG} | -40~+105 | °C |

Electrical & Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Values | | | Unit | Test Condition | |
|---------------------|-------------------|----------------|------|--------|------|----------------|---------------------|
| | | Min. | Typ. | Max. | | | |
| Luminous Intensity | R | I _v | --- | 130 | --- | mcd | I _F =5mA |
| | G | | --- | 420 | --- | | |
| | B | | --- | 100 | --- | | |
| | W | | 350 | 650 | --- | | |
| Forward Voltage | V _F | | 3.8 | --- | 5.5 | V | I _F =5mA |
| Dominant Wavelength | R | λ _D | 615 | --- | 630 | nm | I _F =5mA |
| | G | | 520 | --- | 535 | | |
| | B | | 460 | --- | 475 | | |
| Colour Coordinate | X | --- | --- | 0.2400 | --- | --- | I _F =5mA |
| | Y | | --- | 0.2500 | --- | | |
| Viewing Angle | 2θ _{1/2} | | --- | 120 | --- | deg | I _F =5mA |

Electrical & Optical Characteristics ($T_a=25^\circ\text{C}$, $V_{DD}=5\text{V}$)

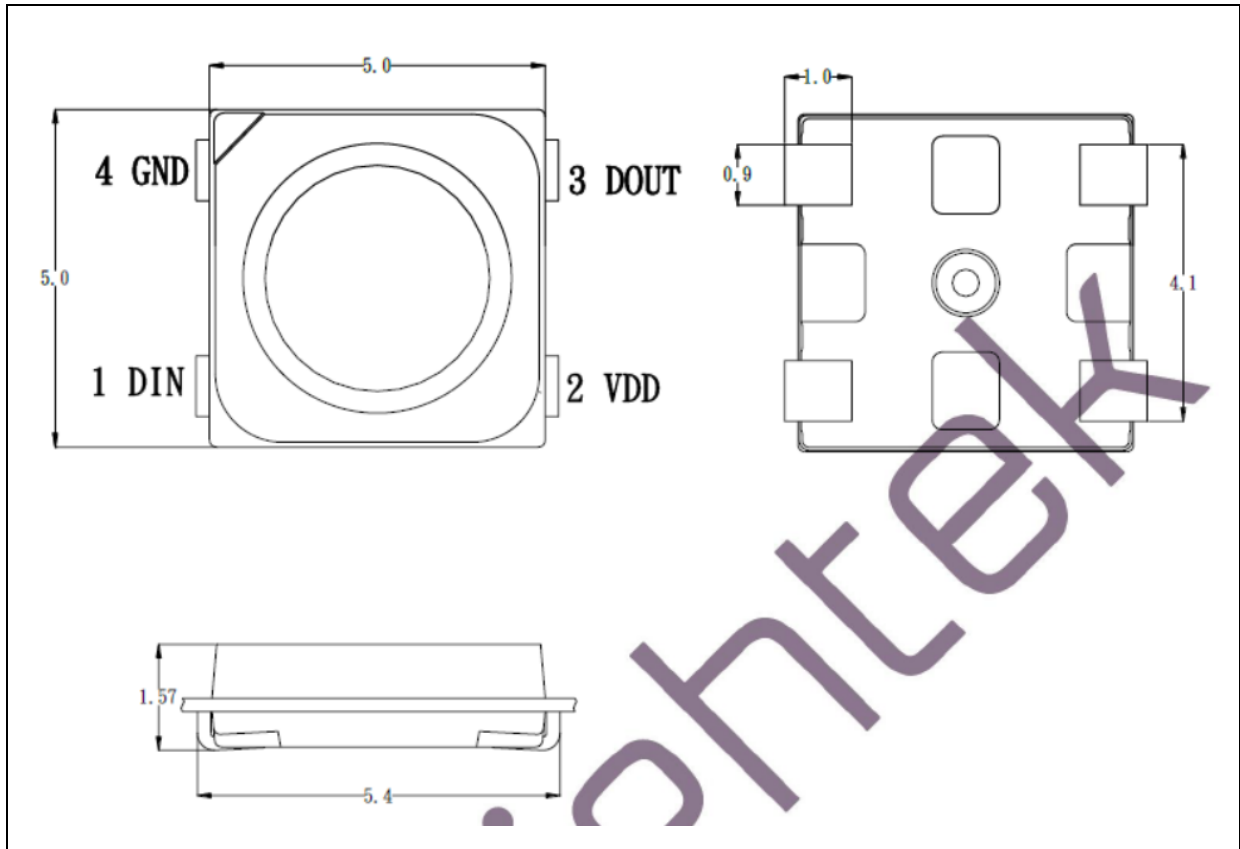
| Parameter | Symbol | Values | | | Unit | Test Condition |
|---------------------|----------|--------------|------|--------------|------|------------------------------------------------|
| | | Min. | Typ. | Max. | | |
| Static Current | I_{DD} | --- | 0.3 | --- | mA | $V_{DD}=4.5\text{V}$ $I_{OUT}=\text{"OFF"}$ |
| Input Voltage Level | V_{IH} | $0.7 V_{DD}$ | --- | --- | V | D_{IN} , SET |
| | V_{IL} | --- | --- | $0.3 V_{DD}$ | V | D_{IN} , SET |

 Switching Characteristics ($T_a=25^\circ\text{C}$, $V_{DD}=5\text{V}$)

| Parameter | Symbol | Values | | | Unit | Test Condition |
|------------------------------------|-----------|--------|------|------|------|------------------------------------------------------------------|
| | | Min. | Typ. | Max. | | |
| Rate of Data Signal | F_{DIN} | --- | 0.8 | --- | MHz | --- |
| Transfer Time | T_{PLH} | --- | --- | 80 | ns | $D_{IN} \rightarrow D_{OUT}$ |
| | T_{PHL} | --- | --- | 80 | ns | |
| Conversion Time of I_{OUT} R/G/B | T_r | --- | --- | 50 | ns | $I_{OUT} R/G/B=5\text{mA}$ $RL=400\Omega$ $CL=15\text{pF}$ |
| | T_f | --- | --- | 100 | ns | |

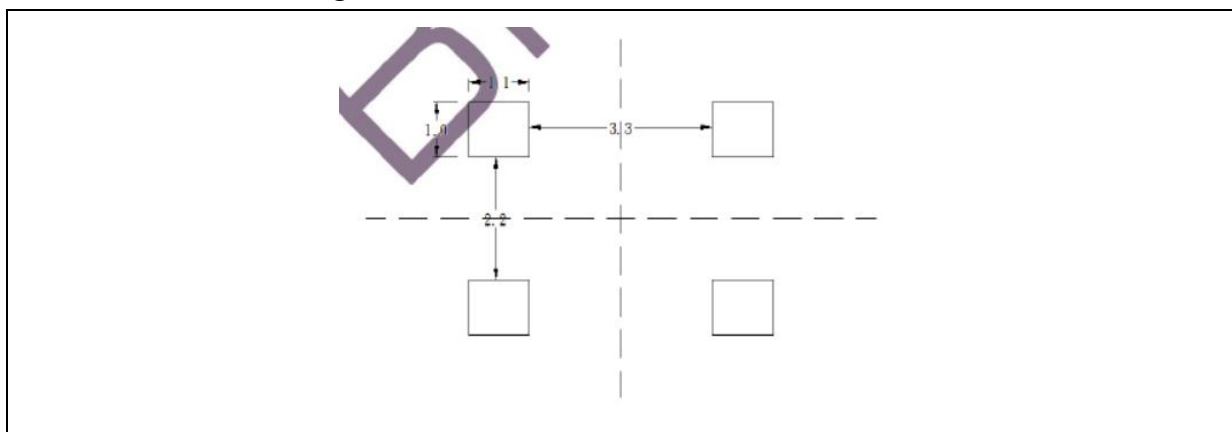
OUTLINE DIMENSION:

Package Dimension:



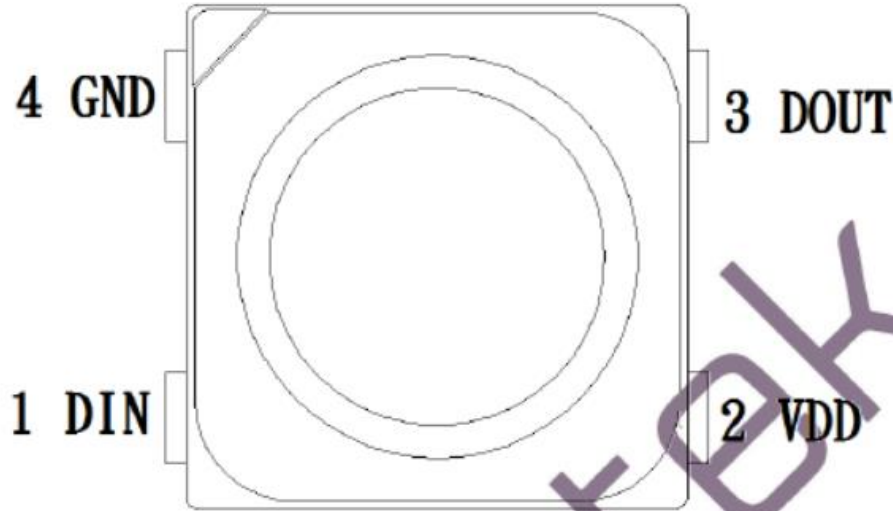
1. All dimensions are in millimetre (mm).
2. Tolerance $\pm 0.2\text{mm}$, unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).
2. Tolerance $\pm 0.1\text{mm}$ with angle tolerance $\pm 0.5^\circ$.

PIN CONFIGURATION:



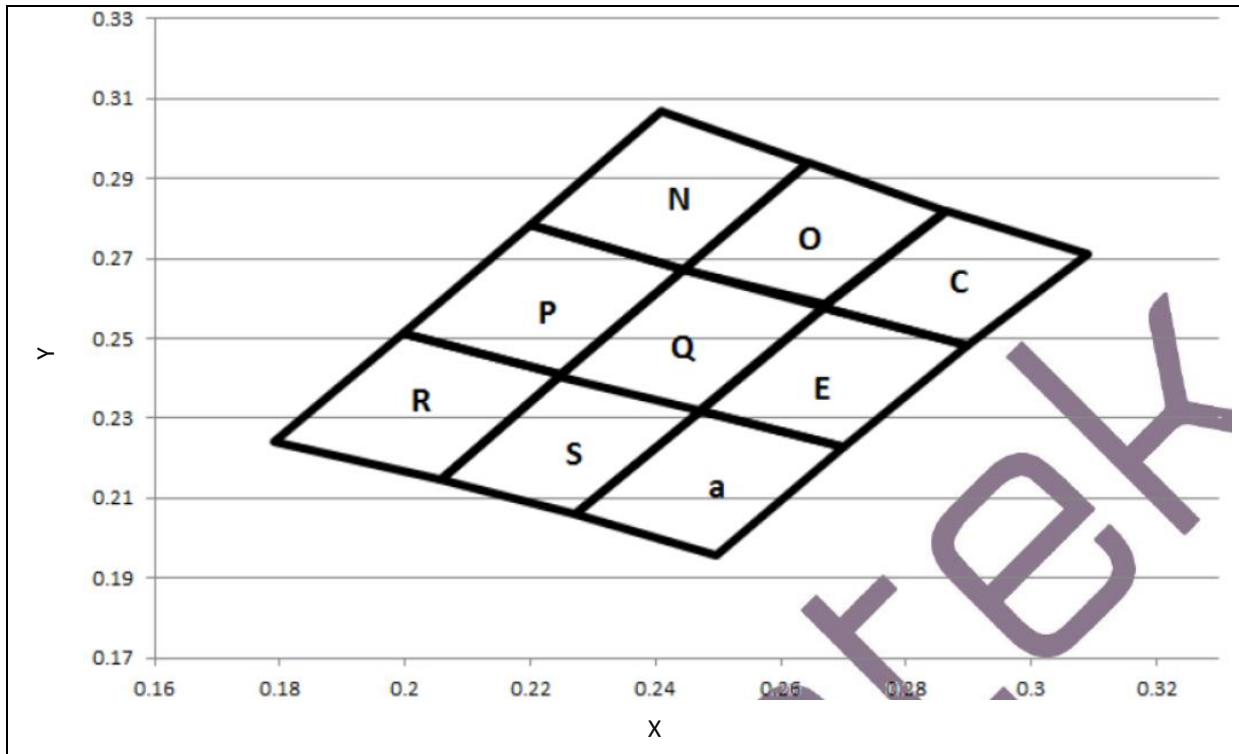
| No. | Symbol | Function Description |
|-----|--------|----------------------------|
| 1 | DIN | Control data signal input |
| 2 | VDD | Power supply LED |
| 3 | DOUT | Control data signal output |
| 4 | GND | Ground |

BINNING GROUPS:

 Luminous Intensity Classifications (White) ($I_f=5\text{mA} \cdot 3$):

| Code | Min. | Max. | Unit |
|------|------|------|------|
| 11 | 350 | 460 | mcd |
| 12 | 460 | 600 | |
| 13 | 600 | 780 | |
| 14 | 780 | 1000 | |
| 15 | 1000 | 1300 | |

CIE CHROMATICITY DIAGRAM:

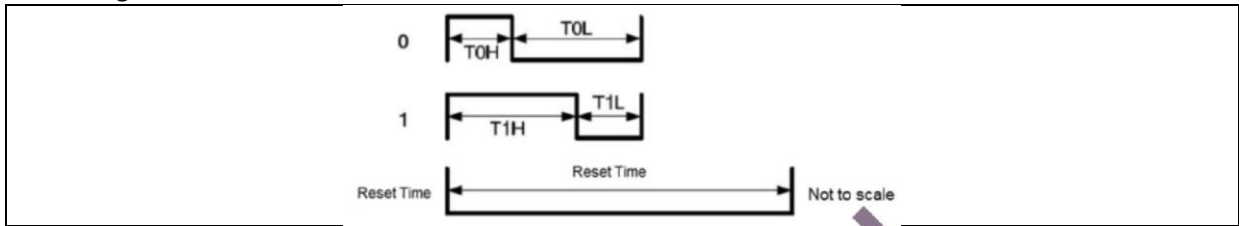


Chromaticity Coordinates Classifications ($I_F = 5\text{mA}$):

| | 1 | | 2 | | 3 | | 4 | |
|---|--------|--------|--------|--------|--------|--------|--------|--------|
| | X | Y | X | Y | X | Y | X | Y |
| N | 0.2200 | 0.2783 | 0.2408 | 0.3068 | 0.2643 | 0.2940 | 0.2444 | 0.2672 |
| O | 0.2444 | 0.2672 | 0.2646 | 0.2940 | 0.2863 | 0.2820 | 0.2671 | 0.2585 |
| C | 0.2865 | 0.2819 | 0.3091 | 0.2712 | 0.2899 | 0.2482 | 0.2667 | 0.2578 |
| P | 0.2200 | 0.2783 | 0.1996 | 0.2513 | 0.2250 | 0.2410 | 0.2444 | 0.2672 |
| Q | 0.2444 | 0.2672 | 0.2244 | 0.2407 | 0.2471 | 0.2320 | 0.2669 | 0.2479 |
| E | 0.2667 | 0.2578 | 0.2899 | 0.2482 | 0.2700 | 0.2227 | 0.2470 | 0.2320 |
| R | 0.1996 | 0.2513 | 0.1792 | 0.2243 | 0.2056 | 0.2148 | 0.2244 | 0.2407 |
| S | 0.2244 | 0.2407 | 0.2056 | 0.2148 | 0.2273 | 0.2061 | 0.2471 | 0.2320 |
| a | 0.2471 | 0.2320 | 0.2273 | 0.2061 | 0.2498 | 0.1959 | 0.2700 | 0.2227 |

DATA TRANSFER TIME (TH+TL=1.2μs±600ns):

1. Timing Wave Form



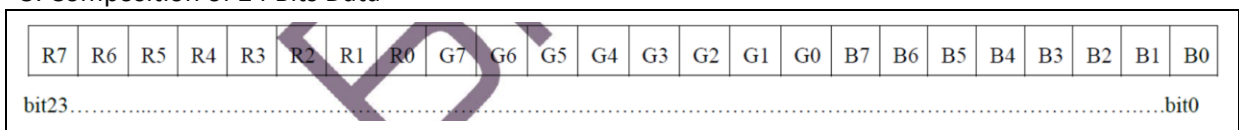
2. High Speed Mode

| Item | Description | Typical | Allowance |
|-----------------|---------------------------|---------|-----------|
| T _{0H} | 0 code, high voltage time | 300ns | ±150ns |
| T _{0L} | 0 code, low voltage time | 900ns | ±150ns |
| T _{1H} | 1 code, high voltage time | 900ns | ±150ns |
| T _{1L} | 1 code, low voltage time | 300ns | ±150ns |
| RES | Reset Time | >200μs | --- |

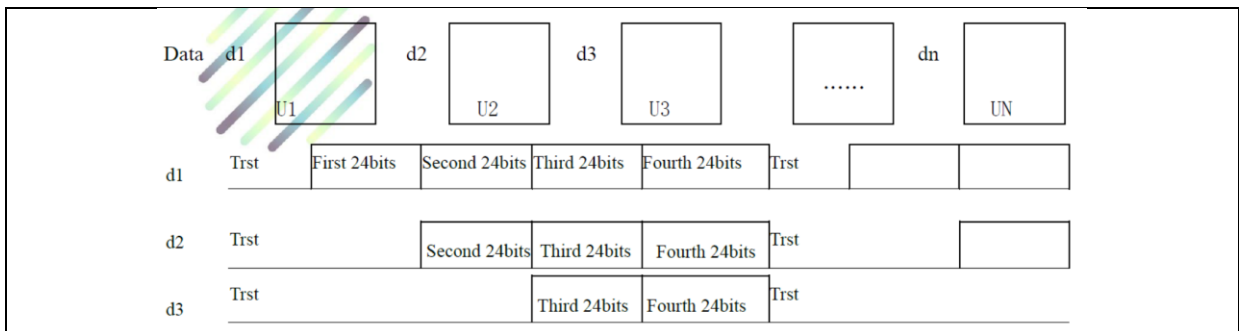
Note:

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- $\Theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial intensity.
- The dominant wavelength, λ_d is derived from CIE chromaticity diagram and represents the single wavelength which defines the colour of the device. Peak emission wavelength tolerance is $\pm 1\text{nm}$.

3. Composition of 24 Bits Data

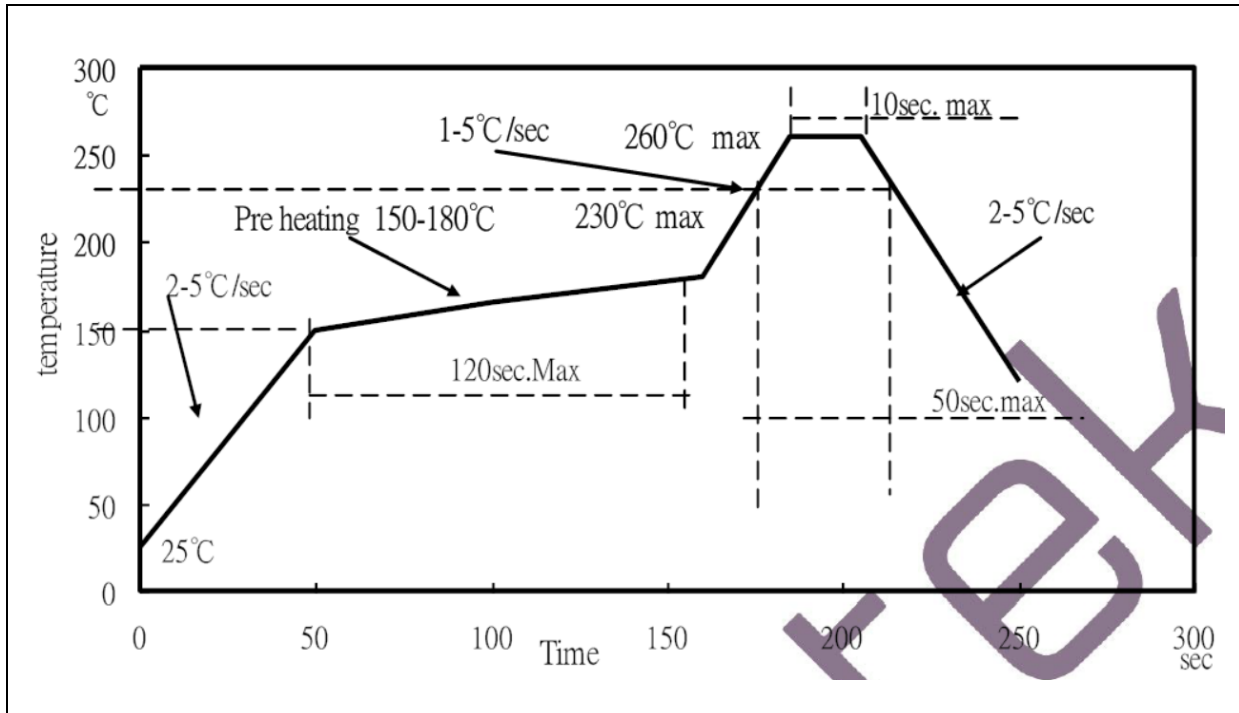


4. Data Transmission Method



RECOMMENDED SOLDERING PROFILE:

Lead-free Solder IR Reflow:

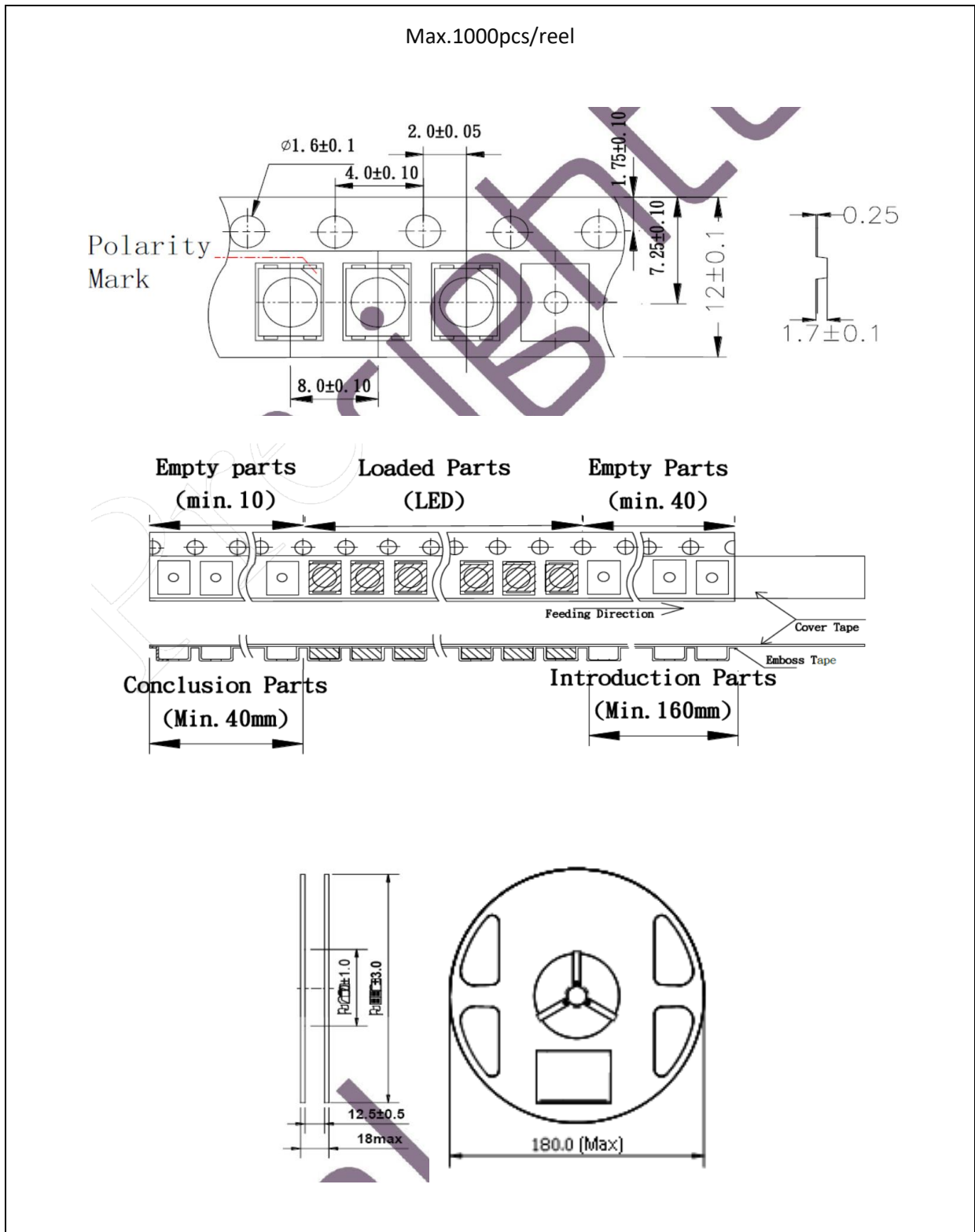


Note:

1. We recommend the reflow temperature 245°C ($\pm 5^\circ\text{C}$). The maximum soldering temperature should be limited to 260°C.
2. Maxima reflow soldering: 1 time.
3. Before, during, and after soldering, should not apply stress on the components and PCB board.

PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 24 hours. Otherwise, they should be kept in a damp-proof box with desiccating agent <10% R.H. and apply baking.

Over-Current Proof:

Must apply resistors for protection otherwise slight voltage shift will cause big current change and burn-out will happen.

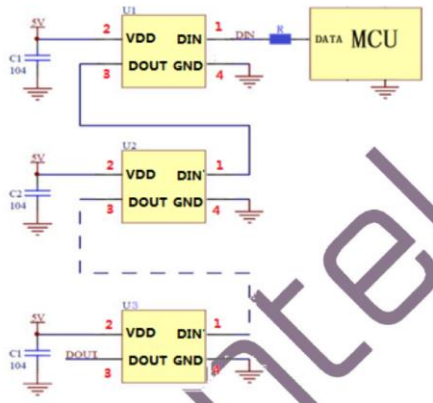
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

REVISION RECORD:

| Version | Date | Summary of Revision |
|---------|------------|---------------------|
| A1.0 | 07/09/2024 | Datasheet set-up. |